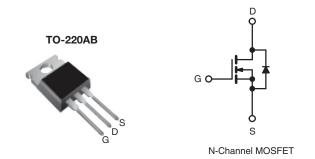


## **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.028				
Q <sub>g</sub> (Max.) (nC)	67	67				
Q <sub>gs</sub> (nC)	18	18				
Q <sub>gd</sub> (nC)	25	25				
Configuration	Sing	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION		
Package	TO-220AB	
Load (Dh) from	IRFZ44PbF	
Lead (Pb)-free	SiHFZ44-E3	
SnPb	IRFZ44	
SHED	SiHFZ44	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	60	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current <sup>e</sup>	T <sub>C</sub> = 25 °C			50		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	- I <sub>D</sub>	36	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	200		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	$P_{D}$	150	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175		
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for 10 s			300	- °C	
Manustina Taurus	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 44  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 51 Å (see fig. 12).
- c.  $I_{SD} \le 51$  A,  $dI/dt \le 250$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C.
- d. 1.6 mm from case.
- e. Current limited by the package, (die current = 51 A).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.0		

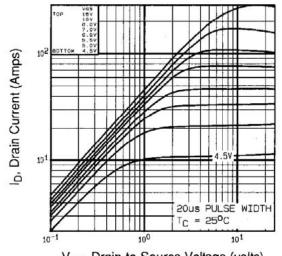
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =	$V_{GS}$ , $I_{D} = 250  \mu A$	2.0	-	4.0	V
Gate-Source Leakage	$I_{GSS}$		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		= 60 V, V <sub>GS</sub> = 0 V	-	-	25	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{DS} = 48 \text{ V}$ $V_{GS} = 10 \text{ V}$	$V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$ $I_{D} = 31 \text{ A}^{b}$	-	-	250 0.028	Ω
Forward Transconductance	9fs		= 25 V, I <sub>D</sub> = 31 A	15	-	=	S
Dynamic	J10		, , ,				
Input Capacitance	C <sub>iss</sub>		V - 0 V	-	1900	-	
Output Capacitance	C <sub>oss</sub>	1	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		920	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	0 MHz, see fig. 5	-	170	-	
Total Gate Charge	Qg			-	-	67	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and $13^b$	-	-	18	nC
Gate-Drain Charge	Q <sub>gd</sub>		3	-	-	25	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> :	= 30 V, I <sub>D</sub> = 51 A,	-	110		
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 9.1 \ \Omega, R_D = 0.55 \ \Omega, see fig. 10^b$		-	45	-	ns
Fall Time	t <sub>f</sub>			-	92	-	
Internal Drain Inductance	$L_{D}$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	cs	-					
Continuous Source-Drain Diode Current	Is	MOSFET sym showing the	MOSFET symbol showing the		-	50	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction		-	-	200	^
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C	$I_{S}$ , $I_{S}$ = 51 A, $V_{GS}$ = 0 $V^{b}$	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T - 25 °C 1	- F1 A dl/dt - 100 A/···	-	120	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = 51 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}$		-	0.53	0.80	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v Ls and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300 \ \mu s$ ; duty cycle  $\leq 2 \ \%$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 1 Typical Output Characteristics, T<sub>C</sub> = 25 °C

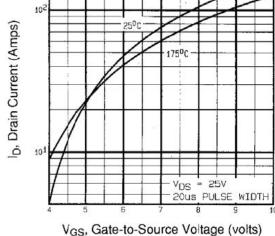
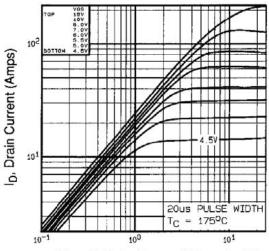


Fig. 3 - Typical Transfer Characteristics



V<sub>DS</sub>, Drain-to-Source Voltage (volts)

Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

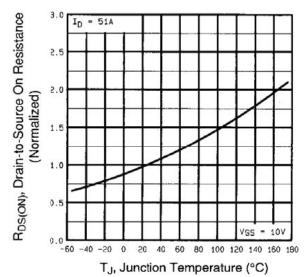


Fig. 4 - Normalized On-Resistance vs. Temperature



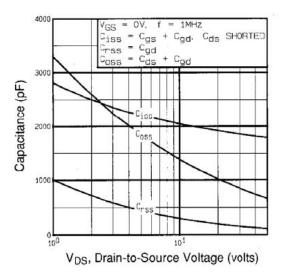


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

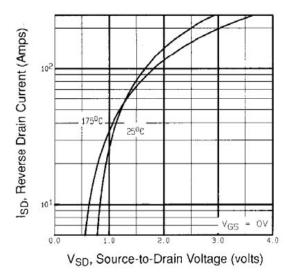


Fig. 7 - Typical Source-Drain Diode Forward Voltage

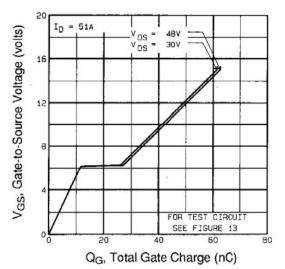


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

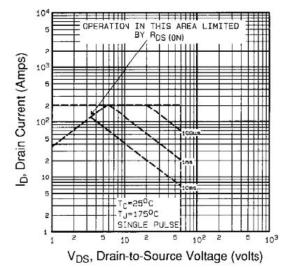


Fig. 8 - Maximum Safe Operating Area





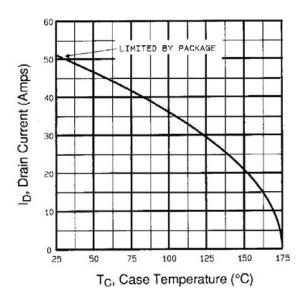


Fig. 9 - Maximum Drain Current vs. Case Temperature

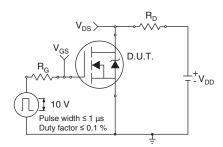


Fig. 10a - Switching Time Test Circuit

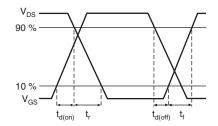


Fig. 10b - Switching Time Waveforms

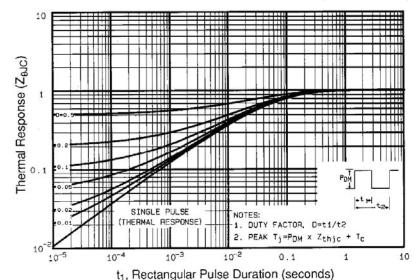


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

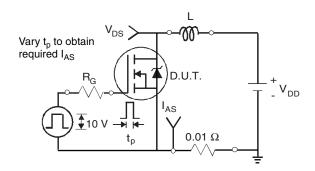


Fig. 12a - Unclamped Inductive Test Circuit

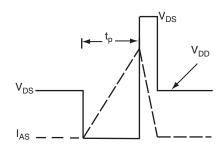


Fig. 12b - Unclamped Inductive Waveforms



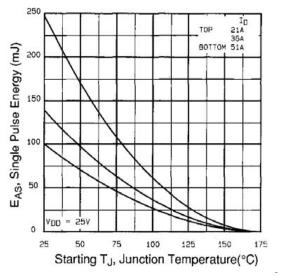


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

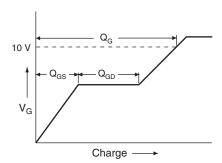


Fig. 13a - Basic Gate Charge Waveform

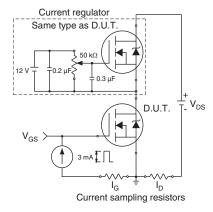
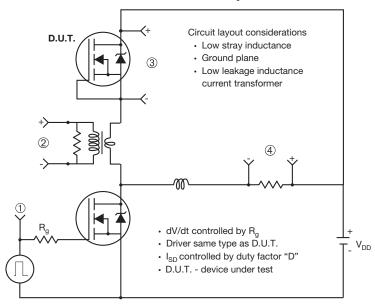


Fig. 13b - Gate Charge Test



### Peak Diode Recovery dV/dt Test Circuit



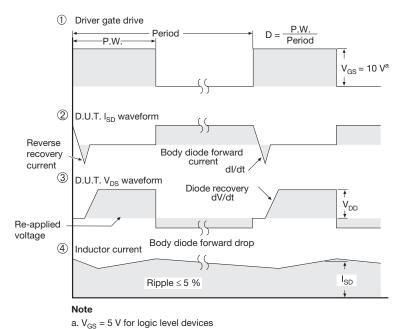


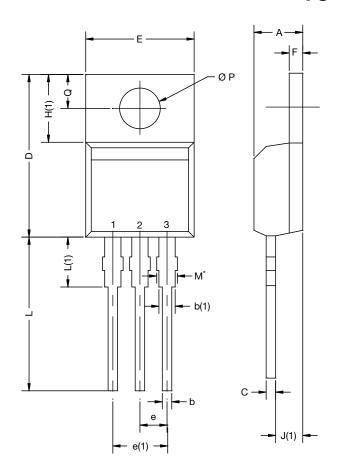
Fig. 14 - For N-Channel

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## TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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